



SURFACE MOUNT

RF Transformer

TC16-1TG2+

50Ω 20 to 300 MHz

FEATURES

- Suitable for tin/lead and RoHS solder systems
- Plastic base with leads
- Aqueous washable



Generic photo used for illustration purposes only

CASE STYLE: AT224-3

+RoHS Compliant

The +Suffix identifies RoHS Compliance. See our website for methodologies and qualifications

APPLICATIONS

- CATV

ELECTRICAL SPECIFICATIONS AT +25°C

| Parameter | Frequency (MHz) | Min. | Typ. | Max. | Unit |
|-------------------------------------|-----------------|------|------|------|------|
| Impedance Ratio (Secondary/Primary) | | | 16 | | |
| Frequency Range | | 20 | | 300 | MHz |
| Insertion Loss* | 20-300 | | 3.0 | | dB |
| | 30-200 | | 2.0 | | |
| | 50-150 | | 1.0 | | |
| Phase Unbalance | 50-150 | | 4 | | Deg. |
| | 30-200 | | 5 | | |
| Amplitude Unbalance | 50-150 | | 0.3 | | dB |
| | 30-200 | | 0.5 | | |

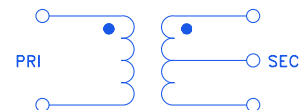
*Insertion Loss is referenced to mid-band loss, 1.0 dB typ.

MAXIMUM RATINGS

| Parameter | Ratings |
|-----------------------|----------------|
| Operating Temperature | -20°C to 85°C |
| Storage Temperature | -55°C to 100°C |
| RF Power | 0.25W |
| DC Current | 30mA |

Permanent damage may occur if any of these limits are exceeded.

CONFIG. A



REV. C
ECO-022233
TC16-1TG2+
MCL NY
240626





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Mini-Circuits

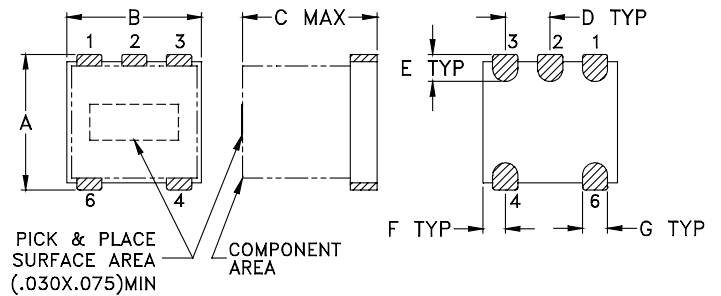
50Ω 20 to 300 MHz

PIN CONNECTIONS

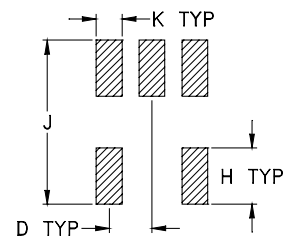
| Function | Pin Number |
|---------------|------------|
| PRIMARY DOT | 3 |
| PRIMARY | 1 |
| SECONDARY DOT | 4 |
| SECONDARY | 6 |
| SECONDARY CT | 2 |

PRODUCT MARKING: N/A

OUTLINE DRAWING



PCB Land Pattern



Suggested Layout,
Tolerance to be within ±.002

OUTLINE DIMENSIONS (Inch mm)

| | | | | | |
|------|------|------|------|------|-------|
| A | B | C | D | E | F |
| .150 | .150 | .150 | .050 | .030 | .025 |
| 3.81 | 3.81 | 3.81 | 1.27 | 0.76 | 0.64 |
| G | H | J | K | | wt |
| .028 | .065 | .190 | .030 | | grams |
| 0.71 | 1.65 | 4.83 | 0.76 | | 0.10 |

TAPE & REEL INFORMATION: F17



SURFACE MOUNT

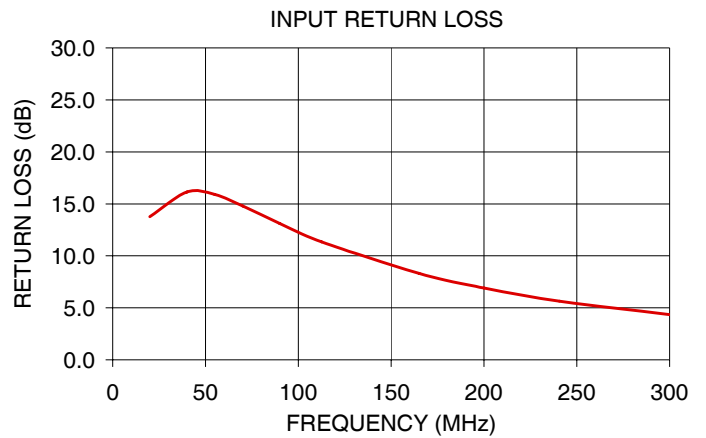
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50Ω 20 to 300 MHz

TYPICAL PERFORMANCE DATA

| FREQUENCY (MHz) | INSERTION LOSS (dB) | INPUT R. LOSS (dB) |
|-----------------|---------------------|--------------------|
| 20.00 | 1.34 | 13.77 |
| 40.00 | 1.07 | 16.14 |
| 55.00 | 1.01 | 15.90 |
| 70.00 | 0.99 | 14.80 |
| 90.00 | 1.00 | 13.12 |
| 112.50 | 1.07 | 11.35 |
| 165.00 | 1.46 | 8.32 |
| 200.00 | 1.70 | 6.90 |
| 240.60 | 2.04 | 5.63 |
| 300.00 | 2.50 | 4.34 |



NOTES

- A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
- B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
- C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the standard terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/terms/viewterm.html

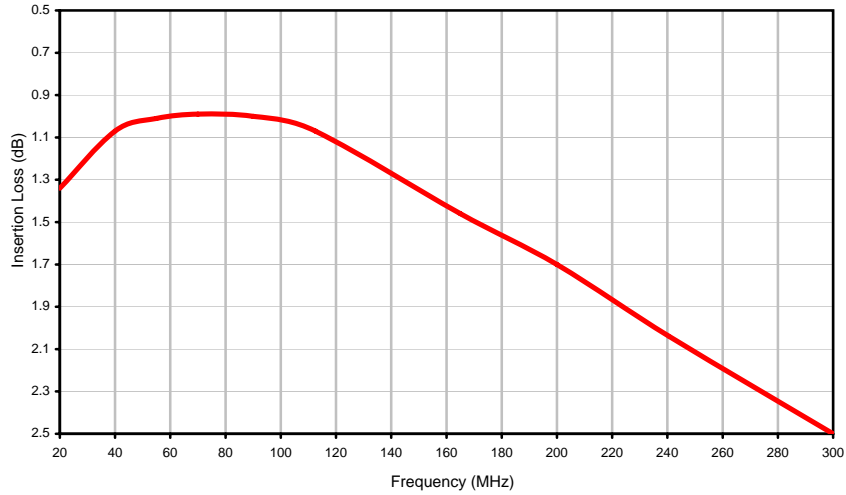


Typical Performance Data

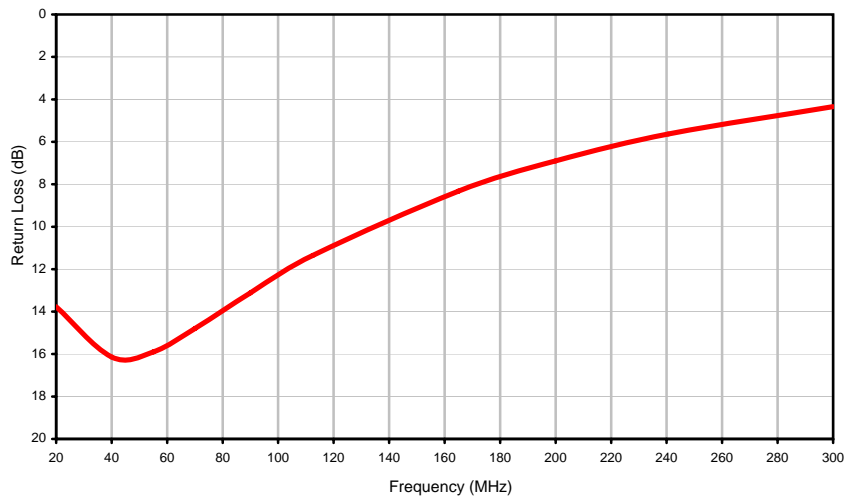
| FREQUENCY (MHz) | INSERTION LOSS (dB) | RETURN LOSS (dB) |
|--------------------|---------------------------|------------------------|
| 20.00 | 1.34 | 13.77 |
| 40.00 | 1.07 | 16.14 |
| 55.00 | 1.01 | 15.90 |
| 70.00 | 0.99 | 14.80 |
| 90.00 | 1.00 | 13.12 |
| 112.50 | 1.07 | 11.35 |
| 165.00 | 1.46 | 8.32 |
| 200.00 | 1.70 | 6.90 |
| 240.60 | 2.04 | 5.63 |
| 300.00 | 2.50 | 4.34 |

Typical Performance Curves

Insertion Loss



Return Loss



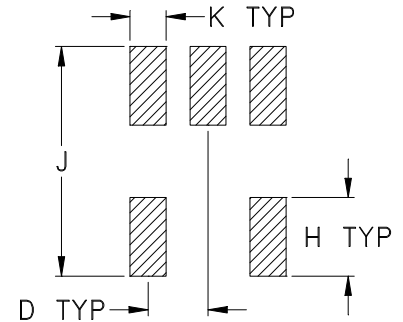
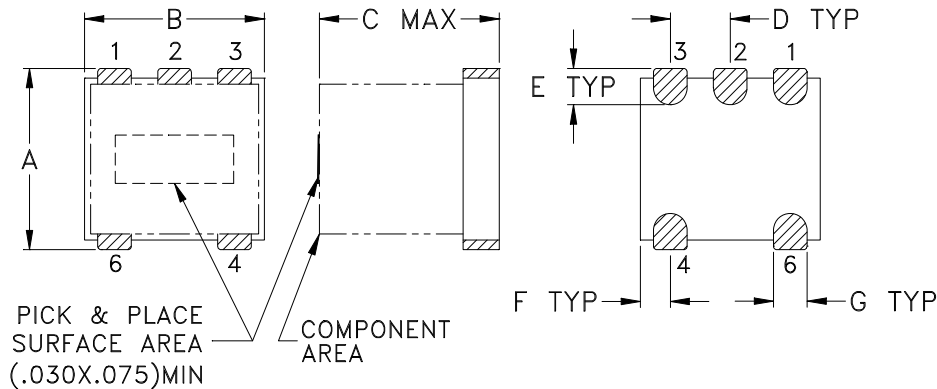
Case Style

AT

Outline Dimensions

AT224-3

PCB Land Pattern



Suggested Layout,
Tolerance to be within ± 0.002

| CASE # | A | B | C | D | E | F | G | H | J | K | L | WT. GRAMS |
|---------|----------------|----------------|----------------|----------------|----------------|----------------|----------------|----------------|----------------|----------------|----------|-----------|
| AT224-3 | .150 (3.81) | .150 (3.81) | .150 (3.81) | .050 (1.27) | .030 (0.76) | .025 (0.64) | .028 (0.71) | .065 (1.65) | .190 (4.83) | .030 (0.76) | -- -- | .10 |

Dimensions are in inches (mm). Tolerances: 2 Pl. $\pm .01$; 3 Pl. $\pm .005$

Notes:

- Open style, ceramic base.
- Termination finish: 3.15-5.12 μ inch (.08-.130 microns) Gold over 78-236 μ inch (1.98-6.0 microns) Nickel plate.



P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661 For detailed performance specs & shopping online see Mini-Circuits web site



The Design Engineers Search Engine Provides ACTUAL Data Instantly From MINI-CIRCUITS At: www.minicircuits.com

RF/IF MICROWAVE COMPONENTS

Tape & Reel Packaging TR-F17

DEVICE ORIENTATION IN T&R



| Tape Width, mm | Device Cavity Pitch, mm | Reel Size, inches | Devices per Reel | |
|----------------|-------------------------|-------------------|-------------------------------------|------|
| 12 | 8 | 7 | Small quantity standards (see note) | 20 |
| | | | | 50 |
| | | | | 100 |
| | | | | 200 |
| | | | | 500 |
| | | 13 | Standard | 1000 |
| | | | 2000 | |

Note: Please Consult individual model data sheet to determine device per reel availability.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf



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RF/IF MICROWAVE COMPONENTS

All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

| Specification | Test/Inspection Condition | Reference/Spec |
|--------------------------------|---|--|
| Operating Temperature | -20° to 85°C Ambient Environment | Individual Model Data Sheet |
| Storage Temperature | -55° to 100° C Ambient Environment | Individual Model Data Sheet |
| Humidity | 90 to 95% RH, 240 hours, 50°C | MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours |
| Thermal Shock | -55° to 100°C, 100 cycles | MIL-STD-202, Method 107, Condition A-3, except +100°C |
| Solder Reflow Heat | Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak | J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1 |
| Solderability | 10X Magnification | J-STD-002, 95% Coverage |
| Vibration (High Frequency) | 20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36) | MIL-STD-202, Method 204, Condition D |
| Mechanical Shock | 50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes | MIL-STD-202, Method 213, Condition A |
| Marking Resistance to Solvents | Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C; distilled water + proylene glycol monomethyl ether + monoethanolamine at 63°C to 70°C | MIL-STD-202, Method 215 |